

**Electronic Patent Application Fee Transmittal****Application Number:** 10516602**Filing Date:** 05-Jul-2005**Title of Invention:** Method of forming a metal pattern and a method of fabricating tft array panel by using the same**First Named Inventor/Applicant Name:** Hong-Sick Park**Filer:** Frank Chau/Scott L. Appelbaum**Attorney Docket Number:** 8071-152T

Filed as Large Entity

**U.S. National Stage under 35 USC 371 Filing Fees****Description****Fee Code****Quantity****Amount****Sub-Total in  
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>180</b>